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TRANSMITTAL FOR U.S. PATENT APPLICATION UNDER 37 CFR §1.53(b)



In re Application of:

Yoshimi (nmi) Takahashi

Serial No.:

To be Determined

Filing Date:

March 2, 2004

Group Art Unit:

Unassigned

Examiner:

Unassigned

Title:

System and Method for Forming Mold Caps Over Integrated

Circuit Devices

MAIL STOP: PATENT APPLICATION

Attorney Docket No. TI-37029 (032350.B586) Express Mail Certificate No. EV 324649632 US

Commissioner For Patents

P.O. Box 1450

Alexandria, Virginia 22313-1450

Sir:

Transmitted herewith for filing is the original patent application of:

Enclosed	are:

X	Specification, Claims and Abstract (23 pages);
X	_ Drawing(s)3_Total Sheet(s) of _X_ Formal Informal;
<u>X</u>	Combined Declaration and Power of Attorney (1 page) X Newly executed (original or copy);
<u>X</u>	An Assignment (1 page) of the invention to Texas Instruments Incorporated is attached. A separate cover sheet (1 page) in compliance with 37 C.F.R. §§ 3.28, .31 is included. Please charge the assignment recordal fee of \$40.00 pursuant to 37 C.F.R. § 1.21(h) to Deposit Account No. 20-0668 of Texas Instruments Incorporated;
<u>X</u>	Certificate of Mailing (1 Page);
_X	_ Texas Instruments Incorporated Return Receipt Postcard (1);
X	_ Baker Botts L.L.P. Return Receipt Postcard (1);
X	This Transmittal (2 pages).

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Applicant is:		
X Large Entity Small Entity		
The accompanying appl X Original.	ication is:	
Continuation		Continuation-In-Part (CIP) of prior application No. incorporated by reference therein.

FEE CALCULATION					FEE	
	Number		Number Extra	Rate	Basic Fee \$ 770.00	
Total Claims	20	- 20		X \$18.00 =	00.00	
Independent Claims	3	-3		X \$86.00 =	00.00	
TOTAL FILING FEE = \$ 770.00						

X Please charge the filing fee of \$770.00 and any other fee required by this paper and credit any overpayment to Deposit Account No. 20-0668 of TEXAS INSTRUMENTS INCORPORATED. This document is being transmitted in duplicate.

BAKER BOTTS L.L.P. Attorneys for Applicant

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Date: March 2, 2004

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Mail Stop: Patent Application

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CERTIFICATE OF MAILING BY EXPRESS MAIL

I hereby certify that the attached Filing Fee Transmittal (2 pages), Patent Application (23 pages), Formal Drawings (3 sheets), Declaration and Power of Attorney (1 page), Assignment of the inventor to Texas Instruments Incorporated (1 page), separate Assignment Recordation coversheet (1 page), return receipt postcard (1 card), and this Certificate of Mailing are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. § 1.10 on this 2nd day of March 2004, and is addressed to the Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.

Willie Tiles

Express Mail Receipt No. EV 324649632 US